

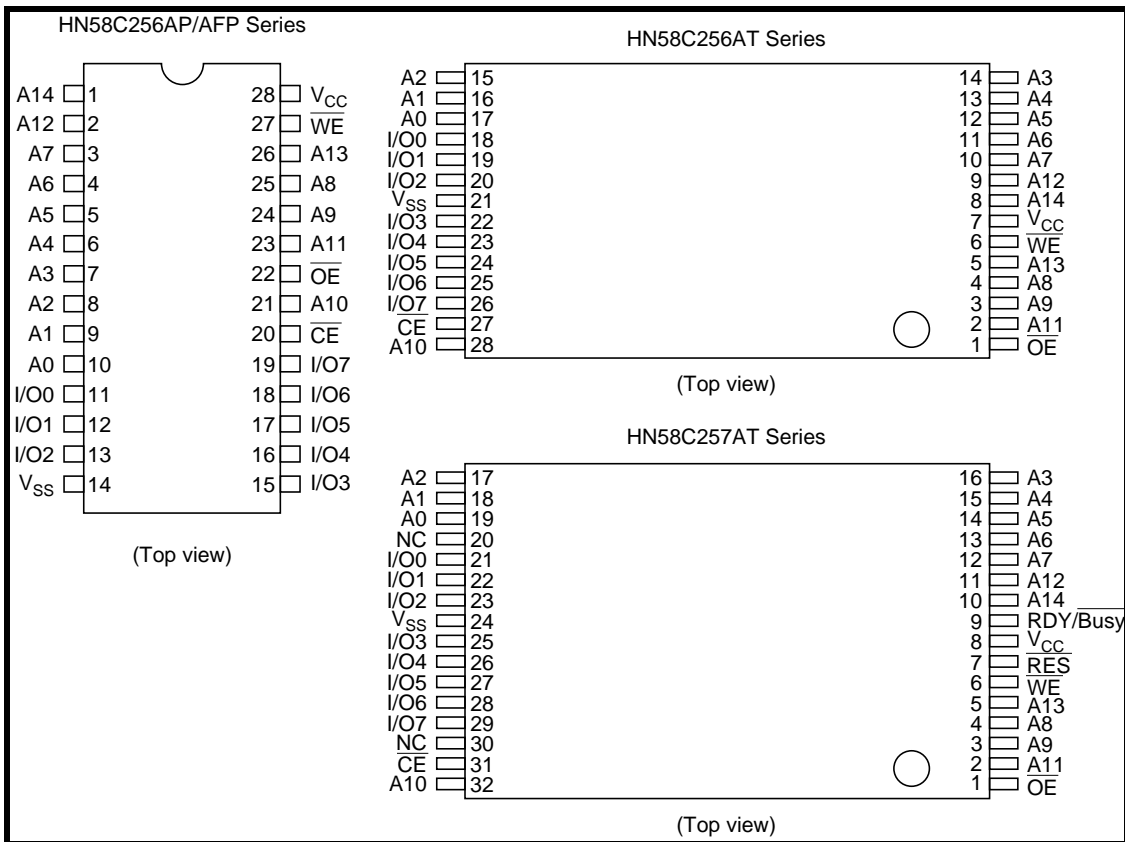


# HN58C256A Series, HN58C257A Series

## Ordering Information

Type No.	Access time	Package
HN58C256AP-85	85 ns	600 mil 28-pin plastic DIP (DP-28)
HN58C256AP-10	100 ns	
HN58C256AFP-85	85 ns	400 mil 28-pin plastic SOP (FP-28D)
HN58C256AFP-10	100 ns	
HN58C256AT-85	85 ns	28-pin plastic TSOP (TFP-28DB)
HN58C256AT-10	100 ns	
HN58C257AT-85	85 ns	8 × 14 mm 32-pin plastic TSOP (TFP-32DA)
HN58C257AT-10	100 ns	

## Pin Arrangement



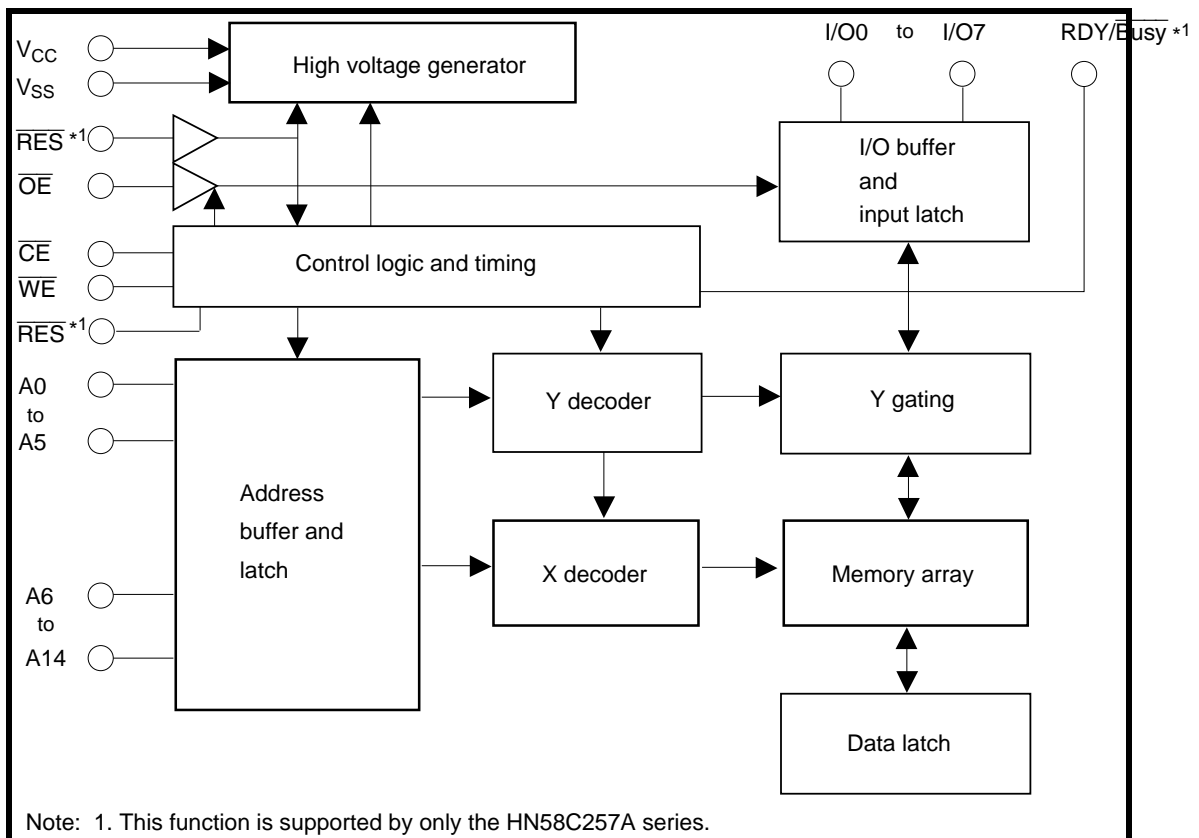
## HN58C256A Series, HN58C257A Series

### Pin Description

Pin name	Function
A0 to A14	Address input
I/O0 to I/O7	Data input/output
$\overline{OE}$	Output enable
$\overline{CE}$	Chip enable
$\overline{WE}$	Write enable
$V_{cc}$	Power supply
$V_{ss}$	Ground
RDY/Busy* <sup>1</sup>	Ready busy
$\overline{RES}^*1$	Reset
NC	No connection

Note: 1. This function is supported by only the HN58C257A series.

### Block Diagram



## HN58C256A Series, HN58C257A Series

### Mode Selection

Pin mode	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	$\overline{RES}^{*3}$	$RDY/\overline{Busy}^{*3}$	I/O
Read	$V_{IL}$	$V_{IL}$	$V_{IH}$	$V_H^{*1}$	High-Z	Dout
Standby	$V_{IH}$	$\times^{*2}$	$\times$	$\times$	High-Z	High-Z
Write	$V_{IL}$	$V_{IH}$	$V_{IL}$	$V_H$	High-Z to $V_{OL}$	Din
Deselect	$V_{IL}$	$V_{IH}$	$V_{IH}$	$V_H$	High-Z	High-Z
Write inhibit	$\times$	$\times$	$V_{IH}$	$\times$	—	—
	$\times$	$V_{IL}$	$\times$	$\times$	—	—
Data polling	$V_{IL}$	$V_{IL}$	$V_{IH}$	$V_H$	$V_{OL}$	Data out (I/O7)
Program reset	$\times$	$\times$	$\times$	$V_{IL}$	High-Z	High-Z

- Notes: 1. Refer to the recommended DC operating condition.  
 2.  $\times$ : Don't care  
 3. This function is supported by only the HN58C257A series.

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Supply voltage <sup>*1</sup>	$V_{CC}$	-0.6 to +7.0	V
Input voltage <sup>*1</sup>	$V_{in}$	-0.5 <sup>*2</sup> to +7.0 <sup>*4</sup>	V
Operating temperature range <sup>*3</sup>	$T_{opr}$	0 to +70	°C
Storage temperature range	$T_{stg}$	-55 to +125	°C

- Notes: 1. With respect to  $V_{SS}$   
 2.  $V_{in\ min} = -3.0\ V$  for pulse width  $\leq 50\ ns$   
 3. Including electrical characteristics and data retention  
 4. Should not exceed  $V_{CC} + 1\ V$ .

## HN58C256A Series, HN58C257A Series

### Recommended DC Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	$V_{CC}$	4.5	5.0	5.5	V
Input voltage	$V_{IL}$	-0.3 <sup>*1</sup>	—	0.6	V
	$V_{IH}$	2.2	—	$V_{CC} + 0.3$ <sup>*2</sup>	V
	$V_H$ <sup>*3</sup>	$V_{CC} - 0.5$	—	$V_{CC} + 1.0$	V
Operating temperature	$T_{opr}$	0	—	70	°C

- Notes: 1.  $V_{IL}$  min: -1.0 V for pulse width  $\leq$  50 ns.  
 2.  $V_{IH}$  max:  $V_{CC} + 1.0$  V for pulse width  $\leq$  50 ns.  
 3. This function is supported by only the HN58C257A series.

### DC Characteristics ( $T_a = 0$ to $+70^\circ\text{C}$ , $V_{CC} = 5.0 \text{ V} \pm 10\%$ )

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input leakage current	$I_{LI}$	—	—	2 <sup>*1</sup>	$\mu\text{A}$	$V_{CC} = 5.5 \text{ V}$ , $V_{in} = 5.5 \text{ V}$
Output leakage current	$I_{LO}$	—	—	2	$\mu\text{A}$	$V_{CC} = 5.5 \text{ V}$ , $V_{out} = 5.5/0.4 \text{ V}$
$V_{CC}$ current (standby)	$I_{CC1}$	—	—	20	$\mu\text{A}$	$\overline{CE} = V_{CC}$
	$I_{CC2}$	—	—	1	$\text{mA}$	$\overline{CE} = V_{IH}$
$V_{CC}$ current (active)	$I_{CC3}$	—	—	12	$\text{mA}$	$I_{out} = 0 \text{ mA}$ , Duty = 100%, Cycle = 1 $\mu\text{s}$ at $V_{CC} = 5.5 \text{ V}$
		—	—	30	$\text{mA}$	$I_{out} = 0 \text{ mA}$ , Duty = 100%, Cycle = 85 ns at $V_{CC} = 5.5 \text{ V}$
Output low voltage	$V_{OL}$	—	—	0.4	V	$I_{OL} = 2.1 \text{ mA}$
Output high voltage	$V_{OH}$	2.4	—	—	V	$I_{OH} = -400 \mu\text{A}$

Note: 1.  $I_{LI}$  on  $\overline{RES} = 100 \mu\text{A}$  max (only the HN58C257A series)

### Capacitance ( $T_a = 25^\circ\text{C}$ , $f = 1 \text{ MHz}$ )

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input capacitance <sup>*1</sup>	$C_{in}$	—	—	6	$\text{pF}$	$V_{in} = 0 \text{ V}$
Output capacitance <sup>*1</sup>	$C_{out}$	—	—	12	$\text{pF}$	$V_{out} = 0 \text{ V}$

Note: 1. This parameter is periodically sampled and not 100% tested.

## HN58C256A Series, HN58C257A Series

AC Characteristics (Ta = 0 to +70°C, V<sub>CC</sub> = 5 V±10%)

### Test Conditions

Input pulse levels: 0 . 4 V t o 3 . 0 V  
0 V to V<sub>CC</sub> ( $\overline{\text{RES}}$  pin\*<sup>2</sup>)

Input rise and fall time: ≤ 20 ns

Input timing reference levels: 0.8, 2.0 V

Output load: 1TTL Gate +100 pF

Output reference levels: 1.5 V, 1.5 V

### Read Cycle

HN58C256A/HN58C257A							
-12							
Parameter	Symbol	Min	Max	Min	Max	Unit	Test conditions
Address to output delay	t <sub>ACC</sub>	—	85	—	100	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{CE}}$ to output delay	t <sub>CE</sub>	—	85	—	100	ns	$\overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{OE}}$ to output delay	t <sub>OE</sub>	10	40	10	50	ns	$\overline{\text{CE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
Address to output hold	t <sub>OH</sub>	0	—	0	—	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{OE}}$ ( $\overline{\text{CE}}$ ) high to output float* <sup>1</sup>	t <sub>DF</sub>	0	40	0	40	ns	$\overline{\text{CE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{RES}}$ low to output float* <sup>1,2</sup>	t <sub>DFR</sub>	0	350	0	350	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{RES}}$ to output delay* <sup>2</sup>	t <sub>RR</sub>	0	450	0	450	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}, \overline{\text{WE}} = V_{\text{IH}}$

Notes: 1. t<sub>DF</sub> and t<sub>DFR</sub> are defined as the time at which the outputs achieve the open circuit conditions and are no longer driven.

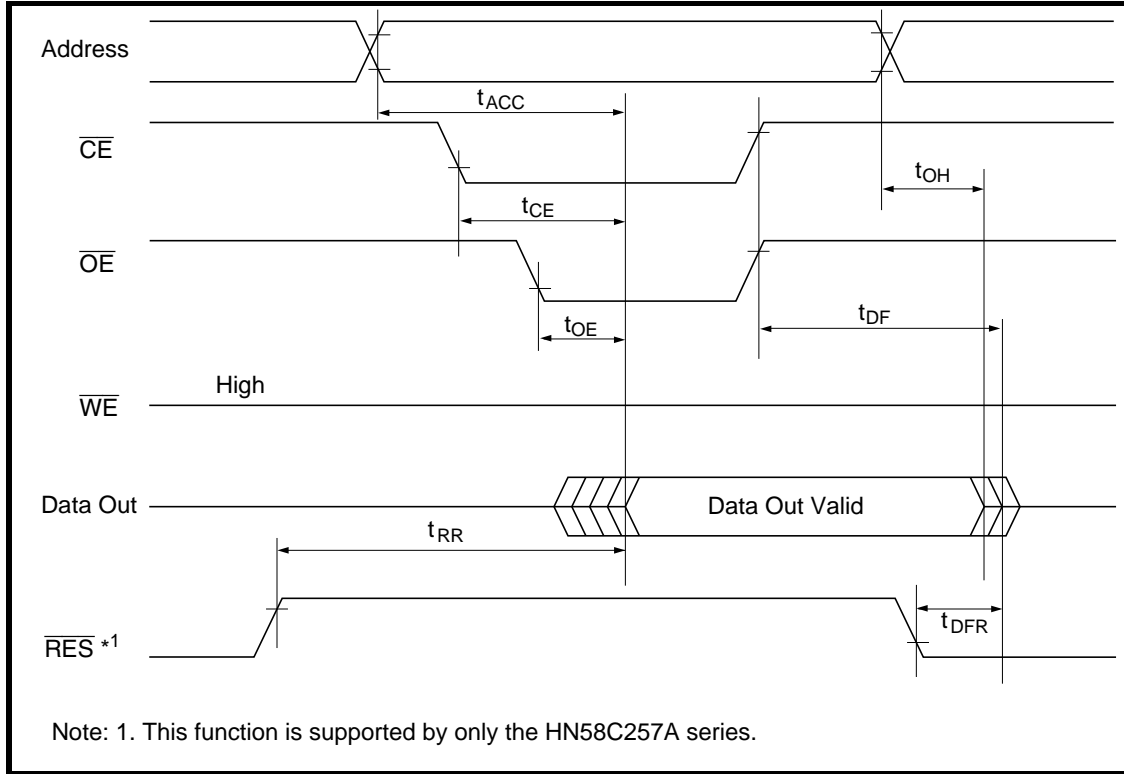
2. This function is supported by only the HN58C257A series.

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## HN58C256A Series, HN58C257A Series

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### Read Timing Waveform



## HN58C256A Series, HN58C257A Series

### Write Cycle

Parameter	Symbol	Min*1	Typ	Max	Unit	Test conditions
Address setup time	$t_{AS}$	0	—	—	ns	
Address hold time	$t_{AH}$	50	—	—	ns	
$\overline{CE}$ to write setup time ( $\overline{WE}$ controlled)	$t_{CS}$	0	—	—	ns	
$\overline{CE}$ hold time ( $\overline{WE}$ controlled)	$t_{CH}$	0	—	—	ns	
$\overline{WE}$ to write setup time ( $\overline{CE}$ controlled)	$t_{WS}$	0	—	—	ns	
$\overline{WE}$ hold time ( $\overline{CE}$ controlled)	$t_{WH}$	0	—	—	ns	
$\overline{OE}$ to write setup time	$t_{OES}$	0	—	—	ns	
$\overline{OE}$ hold time	$t_{OEH}$	0	—	—	ns	
Data setup time	$t_{DS}$	50	—	—	ns	
Data hold time	$t_{DH}$	0	—	—	ns	
$\overline{WE}$ pulse width ( $\overline{WE}$ controlled)	$t_{WP}$	100	—	—	ns	
$\overline{CE}$ pulse width ( $\overline{CE}$ controlled)	$t_{CW}$	100	—	—	ns	
Data latch time	$t_{DL}$	50	—	—	ns	
Byte load cycle	$t_{BLC}$	0.2	—	30	$\mu$ s	
Byte load window	$t_{BL}$	100	—	—	$\mu$ s	
Write cycle time	$t_{WC}$	—	—	$10^{*2}$	ms	
Time to device busy	$t_{DB}$	120	—	—	ns	
Write start time	$t_{DW}$	$0^{*3}$	—	—	ns	
Reset protect time <sup>*4</sup>	$t_{RP}$	100	—	—	$\mu$ s	
Reset high time <sup>*4, 5</sup>	$t_{RES}$	1	—	—	$\mu$ s	

Notes: 1. Use this device in longer cycle than this value.

2.  $t_{WC}$  must be longer than this value unless polling techniques or  $\overline{RDY}/\overline{Busy}$  (only the HN58C257A series) are used. This device automatically completes the internal write operation within this value.

3. Next read or write operation can be initiated after  $t_{DW}$  if polling techniques or  $\overline{RDY}/\overline{Busy}$  (only the HN58C257A series) are used.

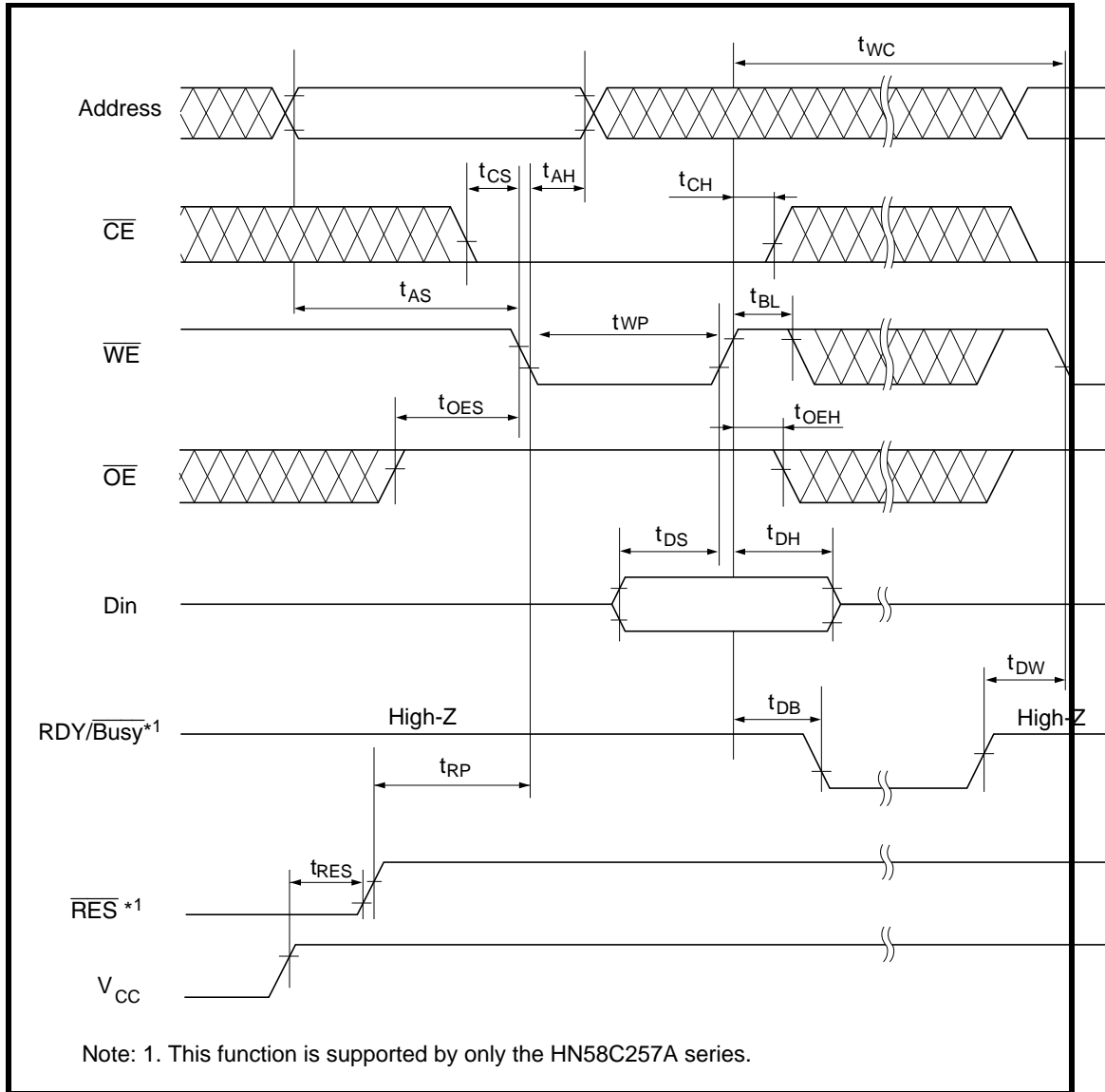
4. This function is supported by only the HN58C257A series.

5. This parameter is sampled and not 100% tested.



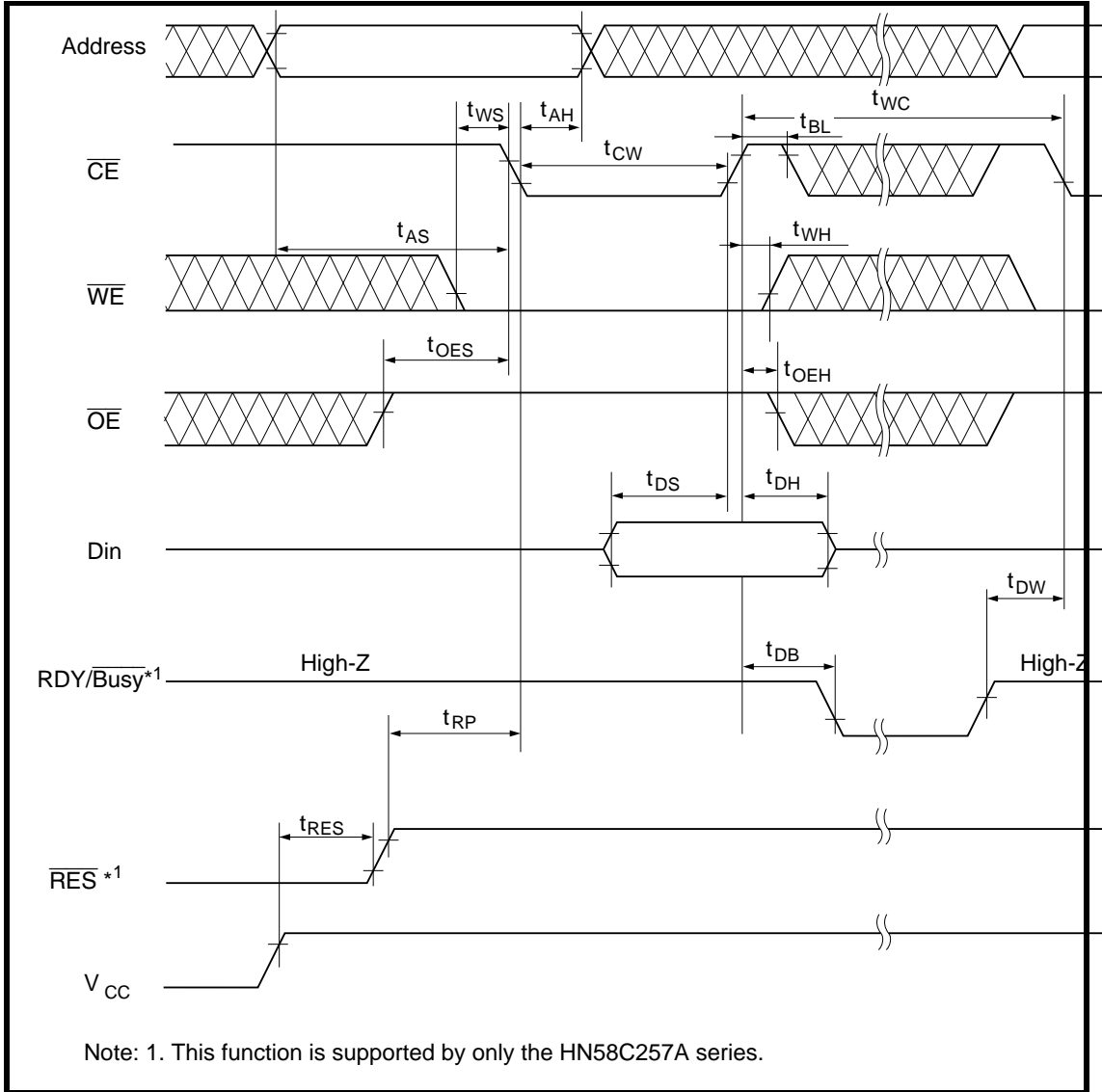
## HN58C256A Series, HN58C257A Series

**Byte Write Timing Waveform (1) ( $\overline{WE}$  Controlled)**



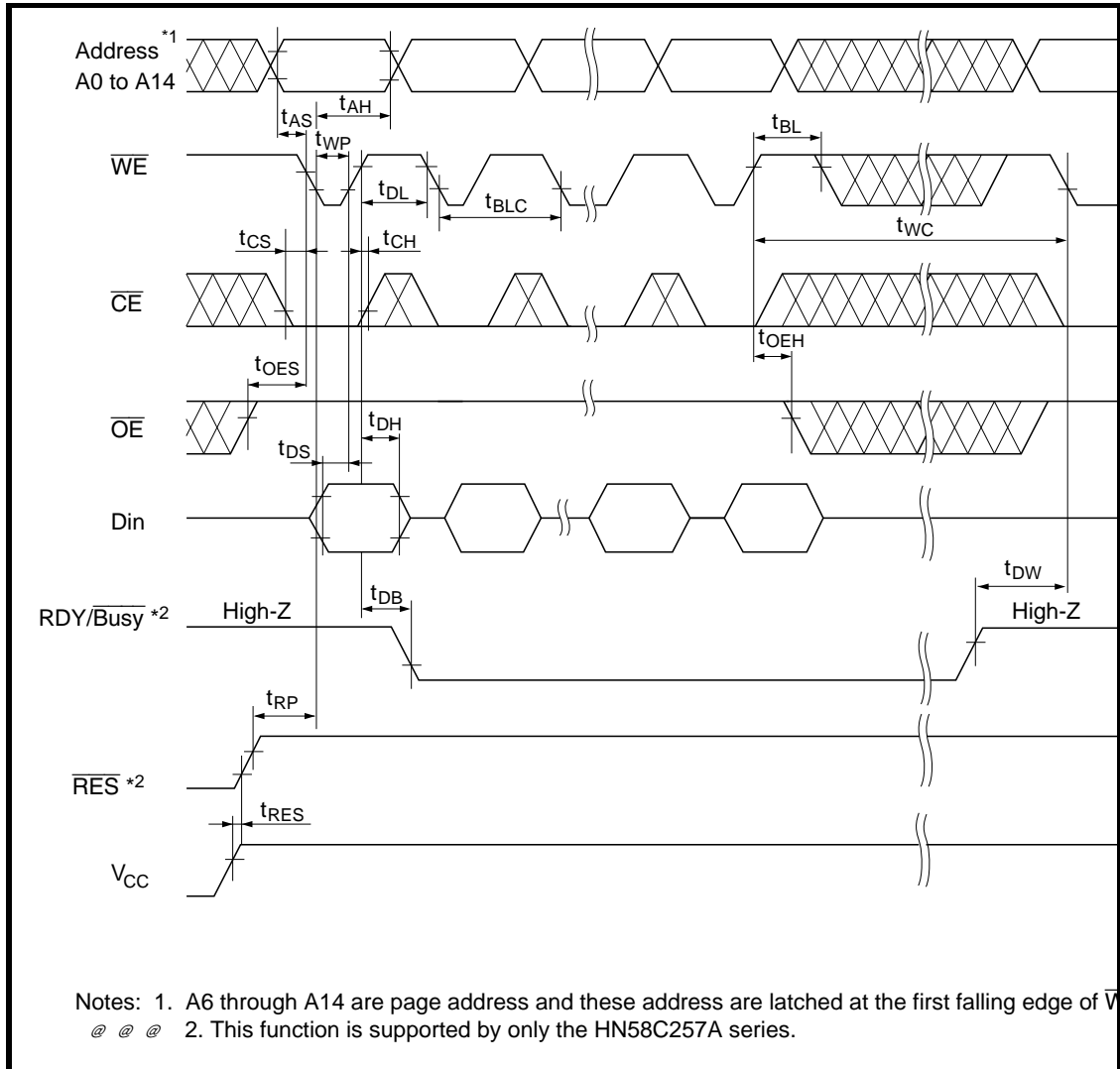
# HN58C256A Series, HN58C257A Series

Byte Write Timing Waveform (2) ( $\overline{CE}$  Controlled)



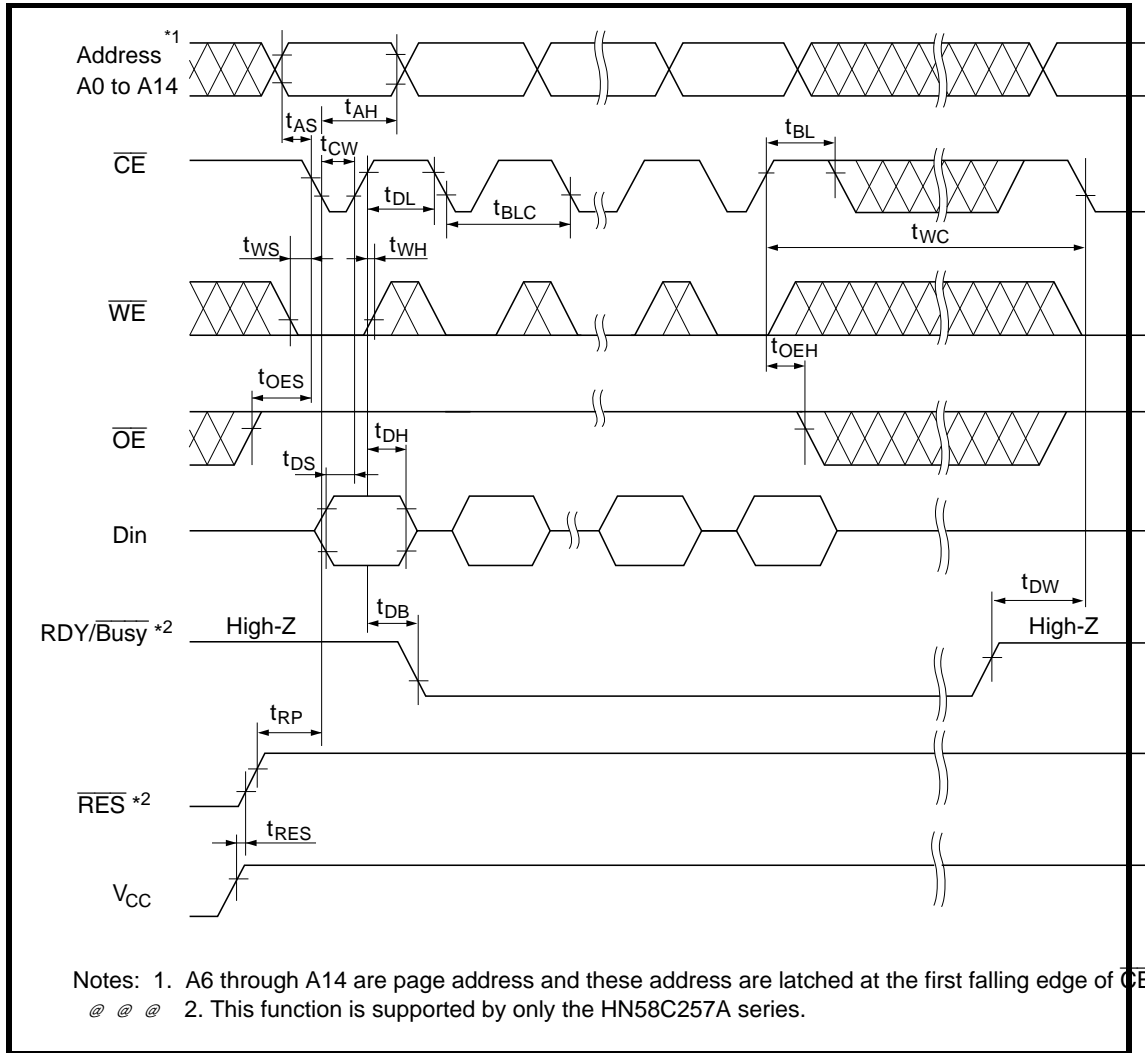
## HN58C256A Series, HN58C257A Series

**Page Write Timing Waveform (1) ( $\overline{WE}$  Controlled)**



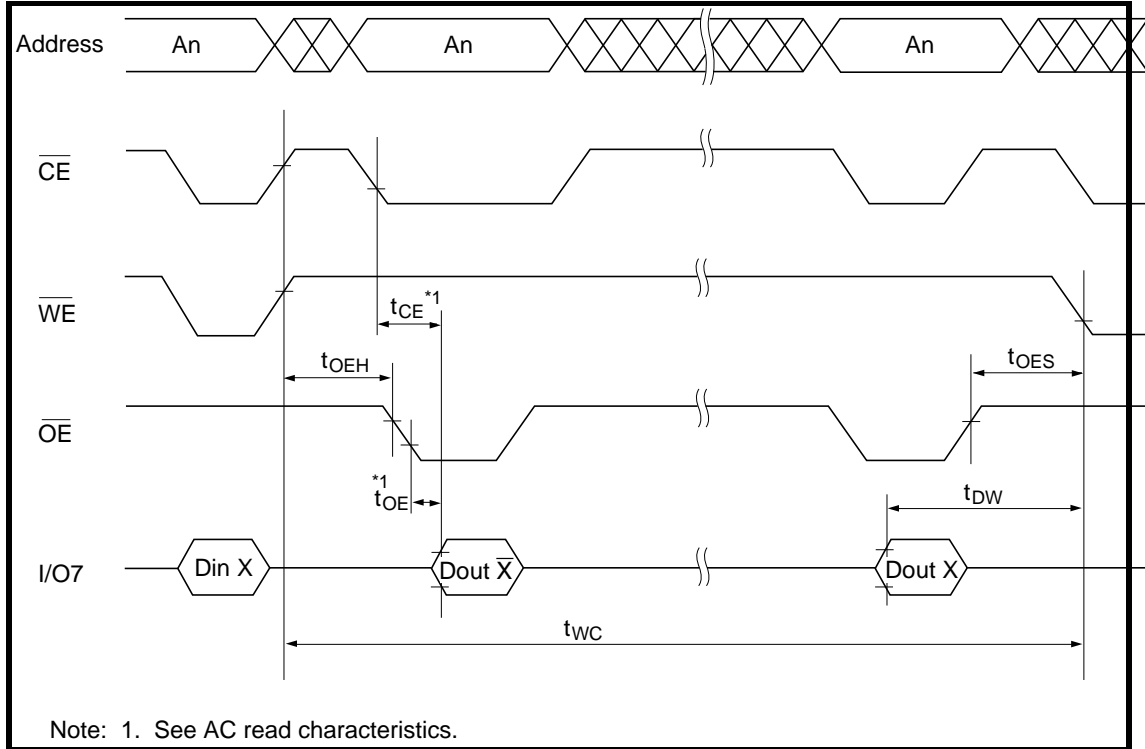
# HN58C256A Series, HN58C257A Series

## Page Write Timing Waveform (2) ( $\overline{CE}$ Controlled)



# HN58C256A Series, HN58C257A Series

## Data Polling Timing Waveform



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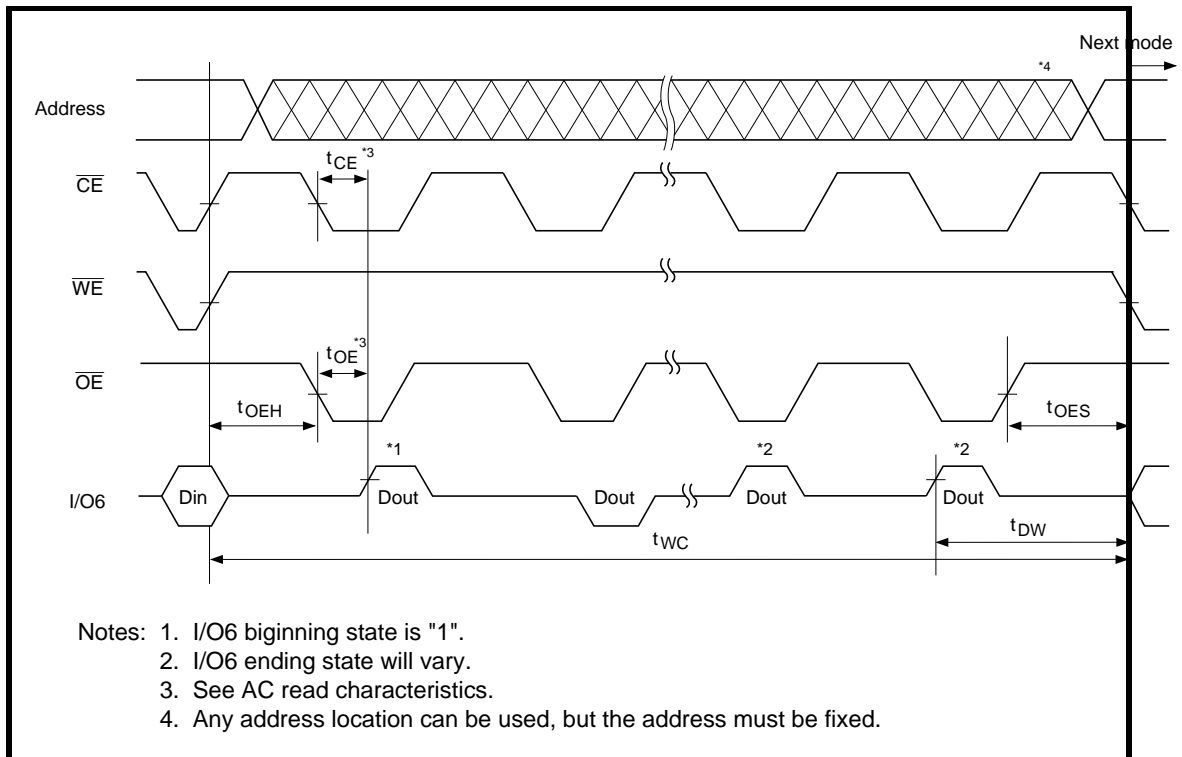
## HN58C256A Series, HN58C257A Series

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### Toggle bit

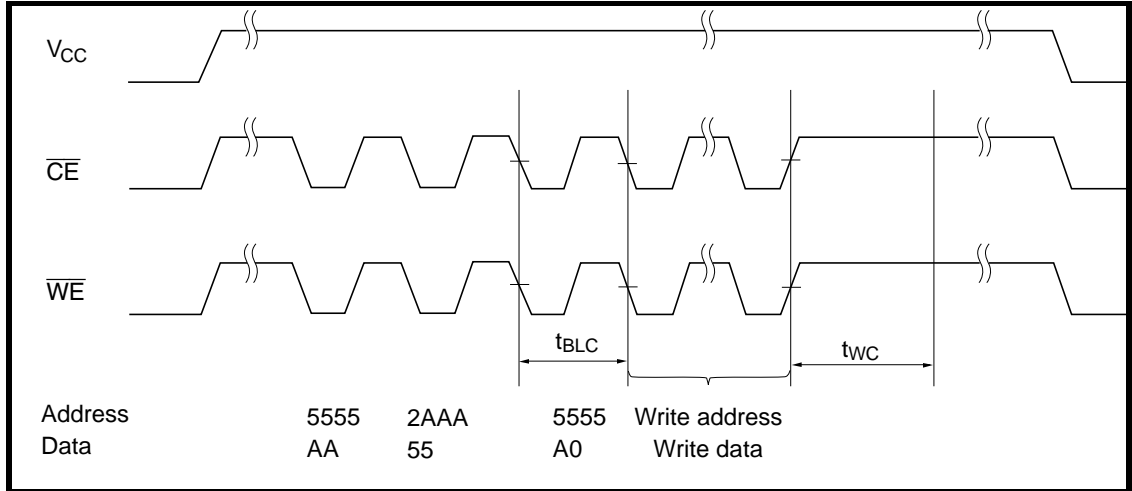
This device provide another function to determine the internal programming cycle. If the EEPROM is set to read mode during the internal programming cycle, I/O6 will charge from "1" to "0" (toggling) for each read. When the internal programming cycle is finished, toggling of I/O6 will stop and the device can be accessible for next read or program.

### Toggle bit Waveform

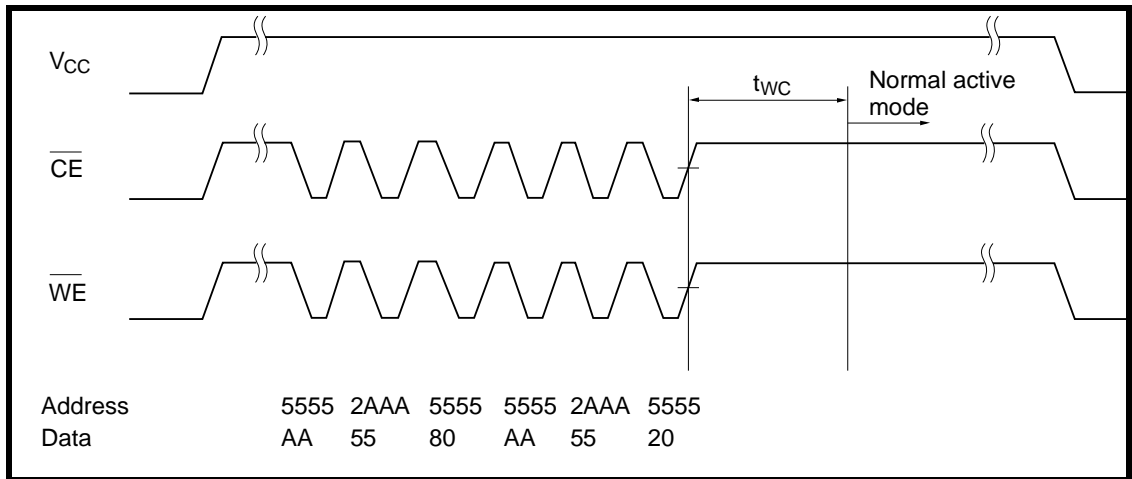


## HN58C256A Series, HN58C257A Series

**Software Data Protection Timing Waveform (1) (in protection mode)**



**Software Data Protection Timing Waveform (2) (in non-protection mode)**



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## HN58C256A Series, HN58C257A Series

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### Functional Description

#### Automatic Page Write

Page-mode write feature allows 1 to 64 bytes of data to be written into the EEPROM in a single write cycle. Following the initial byte cycle, an additional 1 to 63 bytes can be written in the same manner. Each additional byte load cycle must be started within 30  $\mu\text{s}$  from the preceding falling edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ . When  $\overline{\text{CE}}$  or  $\overline{\text{WE}}$  is high for 100  $\mu\text{s}$  after data input, the EEPROM enters write mode automatically and the input data are written into the EEPROM.

#### Data Polling

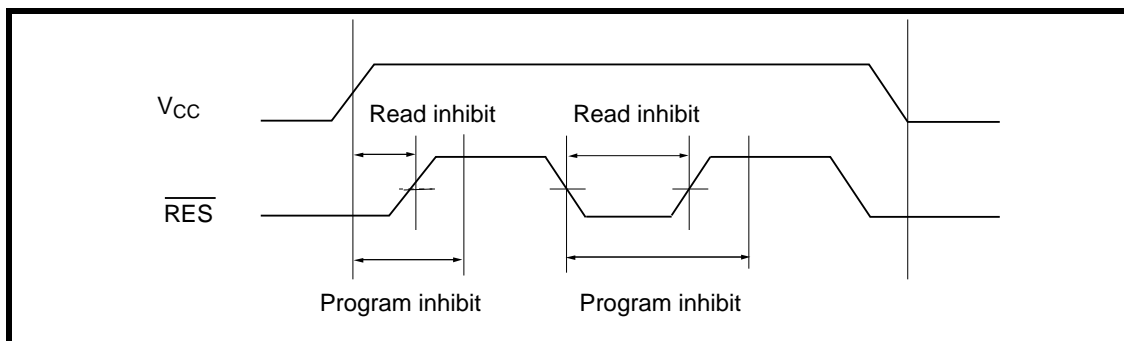
Data polling allows the status of the EEPROM to be determined. If EEPROM is set to read mode during a write cycle, an inversion of the last byte of data to be loaded outputs from I/O7 to indicate that the EEPROM is performing a write operation.

#### $\overline{\text{RDY/Busy}}$ Signal (only the HN58C257A series)

$\overline{\text{RDY/Busy}}$  signal also allows status of the EEPROM to be determined. The  $\overline{\text{RDY/Busy}}$  signal has high impedance except in write cycle and is lowered to  $V_{\text{OL}}$  after the first write signal. At the end of a write cycle, the  $\overline{\text{RDY/Busy}}$  signal changes state to high impedance.

#### $\overline{\text{RES}}$ Signal (only the HN58C257A series)

When  $\overline{\text{RES}}$  is low, the EEPROM cannot be read or programmed. Therefore, data can be protected by keeping  $\overline{\text{RES}}$  low when  $V_{\text{CC}}$  is switched.  $\overline{\text{RES}}$  should be high during read and programming because it doesn't provide a latch function.





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## HN58C256A Series, HN58C257A Series

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### $\overline{\text{WE}}$ , $\overline{\text{CE}}$ Pin Operation

During a write cycle, addresses are latched by the falling edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ , and data is latched by the rising edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ .

### Write/Erase Endurance and Data Retention Time

The endurance is  $10^5$  cycles in case of the page programming and  $10^4$  cycles in case of the byte programming (1% cumulative failure rate). The data retention time is more than 10 years when a device is page-programmed less than  $10^4$  cycles.

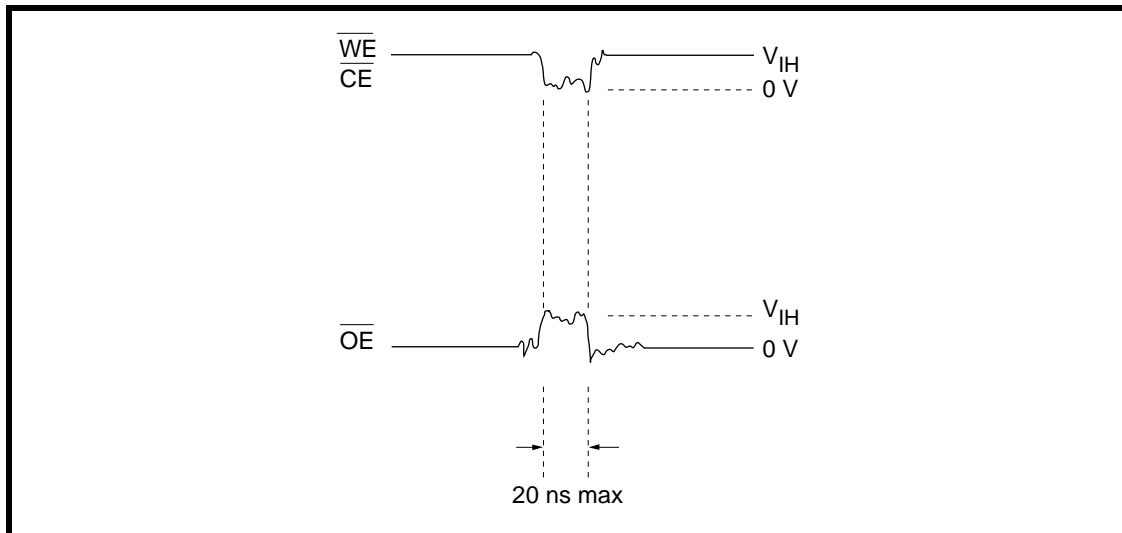
### Data Protection

#### 1. Data Protection against Noise on Control Pins ( $\overline{\text{CE}}$ , $\overline{\text{OE}}$ , $\overline{\text{WE}}$ ) during Operation

During readout or standby, noise on the control pins may act as a trigger and turn the EEPROM to programming mode by mistake.

To prevent this phenomenon, this device has a noise cancelation function that cuts noise if its width is 20 ns or less in program mode.

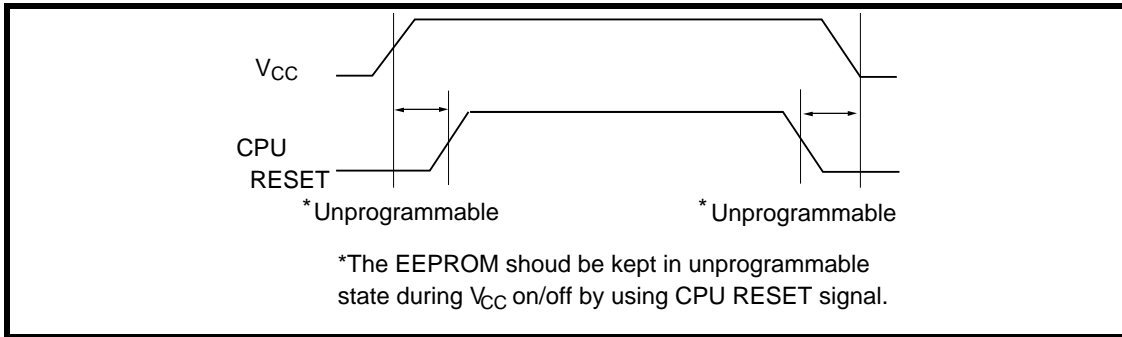
Be careful not to allow noise of a width of more than 20 ns on the control pins.



## HN58C256A Series, HN58C257A Series

### 2. Data Protection at $V_{CC}$ On/Off

When  $V_{CC}$  is turned on or off, noise on the control pins generated by external circuits (CPU, etc) may act as a trigger and turn the EEPROM to program mode by mistake. To prevent this unintentional programming, the EEPROM must be kept in an unprogrammable state while the CPU is in an unstable state.



#### (1) Protection by $\overline{CE}$ , $\overline{OE}$ , $\overline{WE}$

To realize the unprogrammable state, the input level of control pins must be held as shown in the table below.

$\overline{CE}$	$V_{CC}$	x	x
$\overline{OE}$	x	$V_{SS}$	x
$\overline{WE}$	x	x	$V_{CC}$

x: Don't care.

$V_{CC}$ : Pull-up to  $V_{CC}$  level.

$V_{SS}$ : Pull-down to  $V_{SS}$  level.

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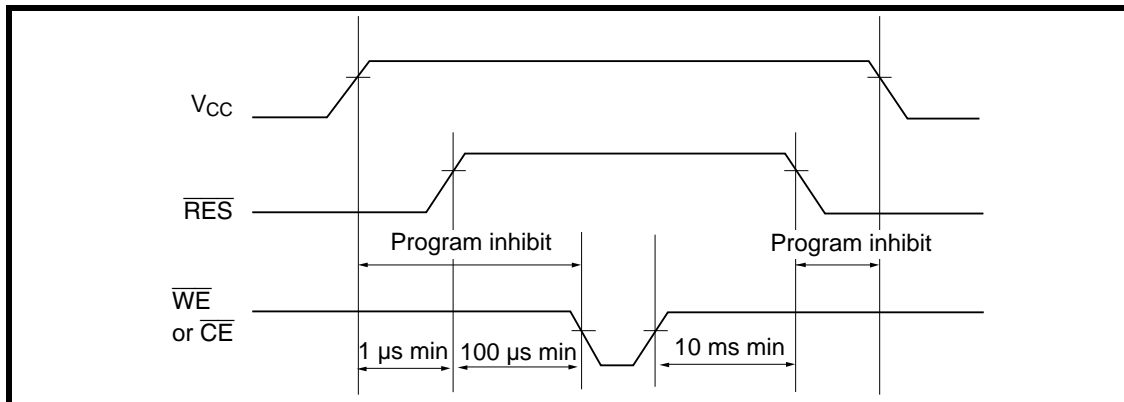
## HN58C256A Series, HN58C257A Series

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(2) Protection by  $\overline{\text{RES}}$  (only the HN58C257A series)

The unprogrammable state can be realized by that the CPU's reset signal inputs directly to the EEPROM's  $\overline{\text{RES}}$  pin.  $\overline{\text{RES}}$  should be kept  $V_{SS}$  level during  $V_{CC}$  on/off.

The EEPROM breaks off programming operation when  $\overline{\text{RES}}$  becomes low, programming operation doesn't finish correctly in case that  $\overline{\text{RES}}$  falls low during programming operation.  $\overline{\text{RES}}$  should be kept high for 10 ms after the last data input.



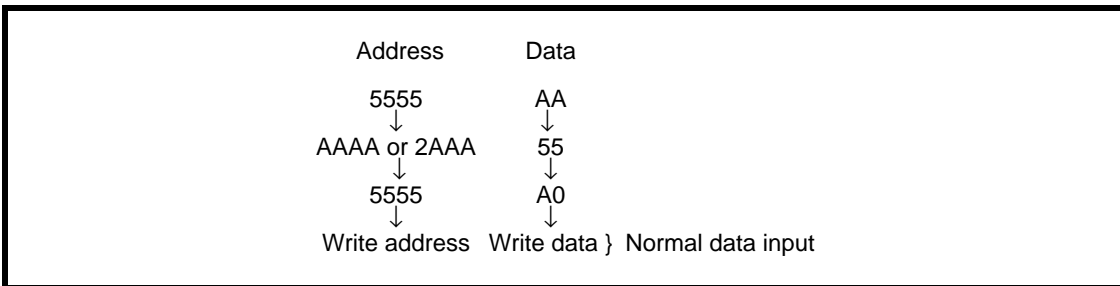
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## HN58C256A Series, HN58C257A Series

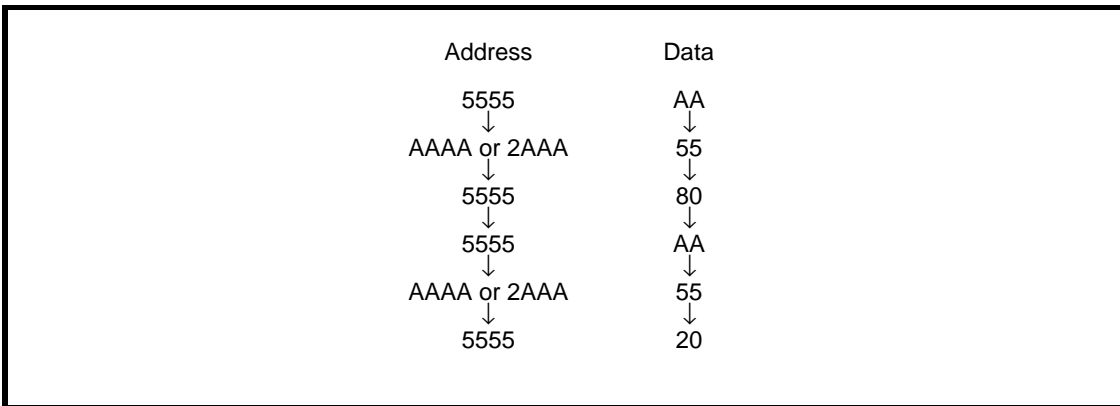
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### 3. Software data protection

To prevent unintentional programming caused by noise generated by external circuits. This device has the software data protection function. In software data protection mode, 3 bytes of data must be input before write data as follows. And these bytes can switch the non-protection mode to the protection mode.



Software data protection mode can be cancelled by inputting the following 6 bytes. After that, this device turns to the non-protection mode and can write data normally. But when the data is input in the cancelling cycle, the data cannot be written.



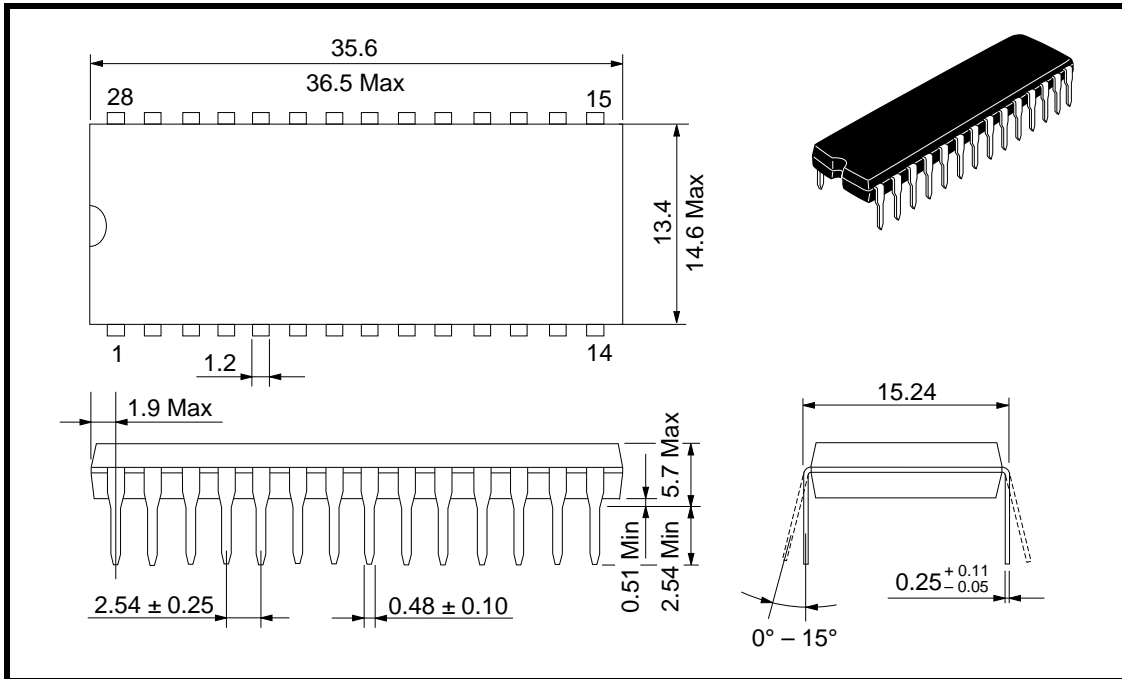
The software data protection is not enabled at the shipment.

## HN58C256A Series, HN58C257A Series

### Package Dimensions

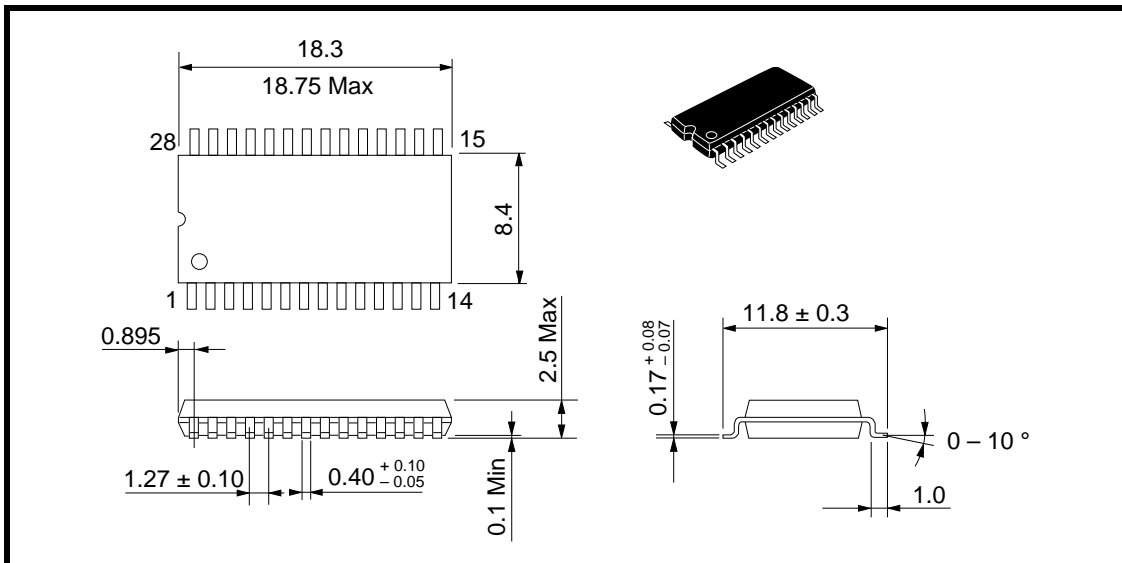
HN58C256AP Series (DP-28)

Unit: mm



HN58C256AFP Series (FP-28D)

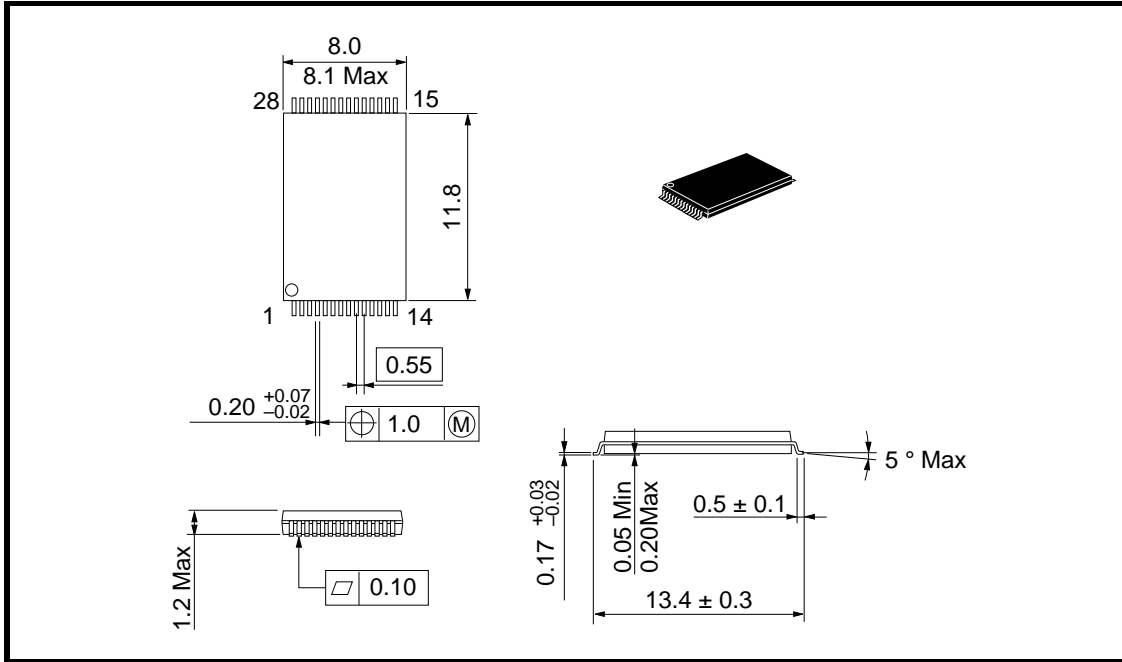
Unit: mm



# HN58C256A Series, HN58C257A Series

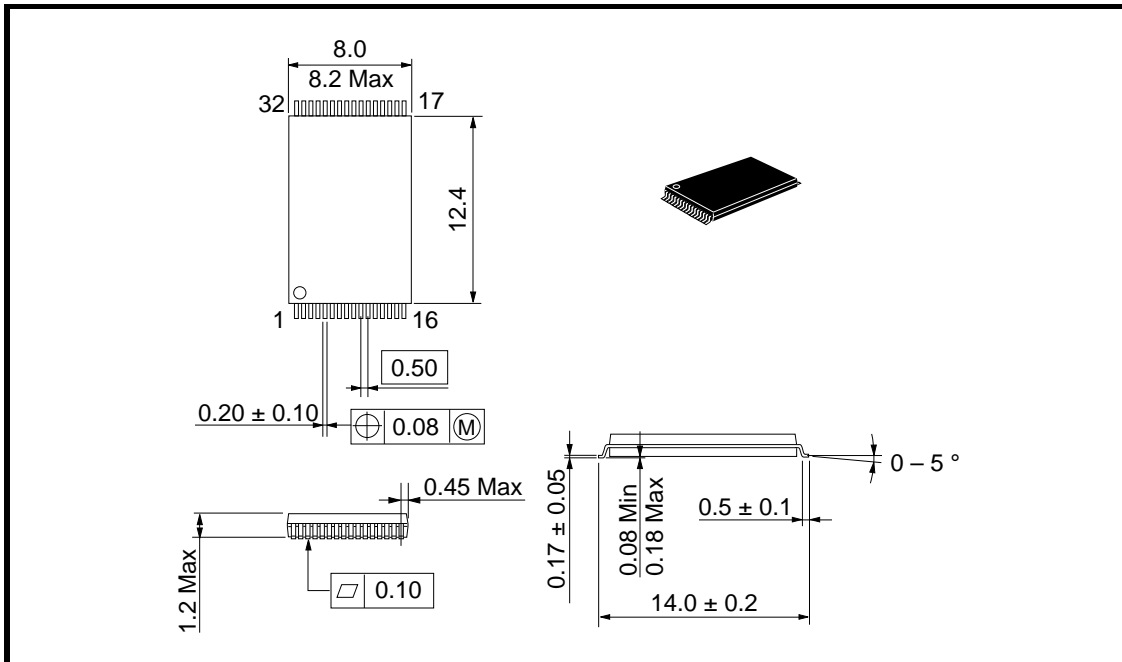
Series (TFP-28DB)

Unit: mm



HN58C257AT Series (TFP-32DA)

Unit: mm



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## HN58C256A Series, HN58C257A Series

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## HN58C256A Series, HN58C257A Series

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### Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Jun. 19, 1995	Initial issue	Y. Nagai	T. Muto
1.0	May. 17, 1996	Change of format Absolute Maximun Ratings Addition of note 4 Recommended DC Operating Conditions $V_{IH}$ (min): 3.0 V to 2.2 V AC Characteristics $V_{OH}$ (min): $V_{CC} \times 0.8$ V to 2.4 V AC Characteristics Input pulse levels: 0 V to 3.0 V to 0.4 V to 3.0 V Data Polling Timing Waveform Addition of note 1 Toggle bit Waveform Addition of note 4		

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